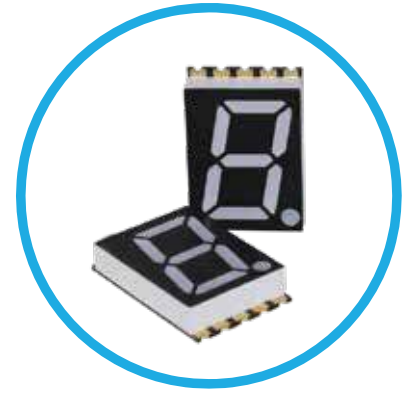


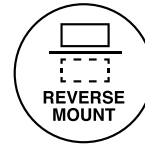
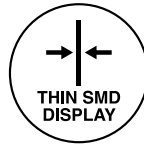


DSM7T Series

Thin Surface Mount Single Digit 7-Segment LED Numeric Display



DSM7TA56105T - 0.56" (14.22mm) Digit Height
Emitting Color: Pure-Green (InGaN)



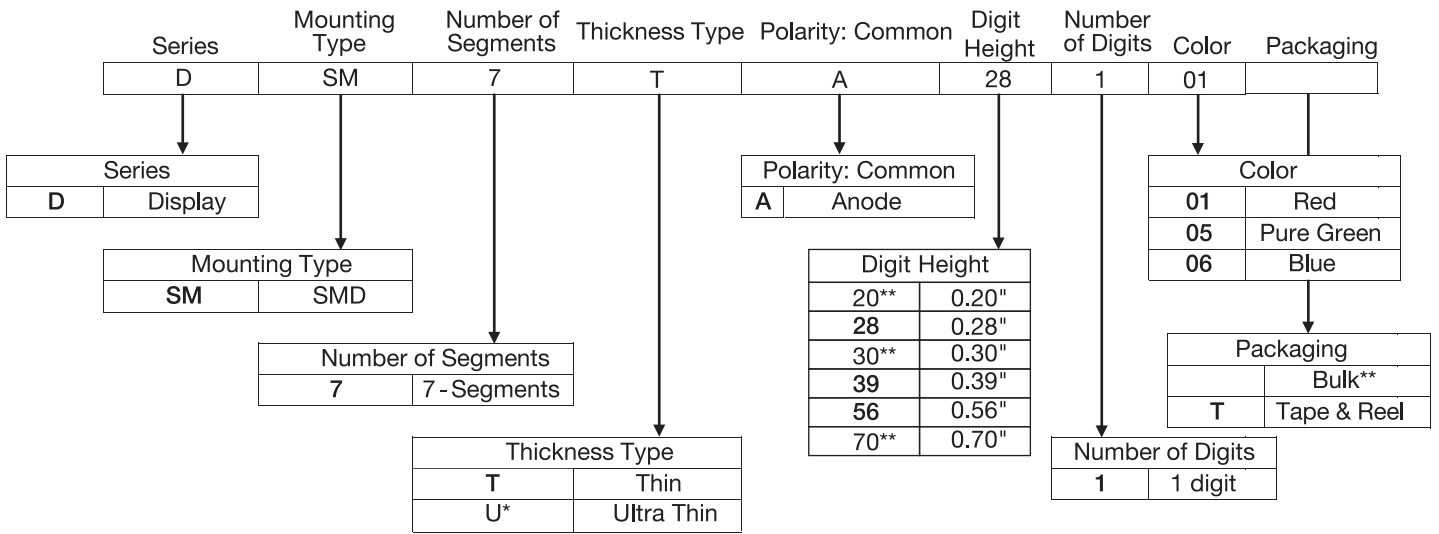
Application

- People Movers
- Home Appliances
- Medical Devices
- Industrial Devices
- Automation and Controls
- Light Control
- IoT
- Transportation
- Food Service Appliances

Key features

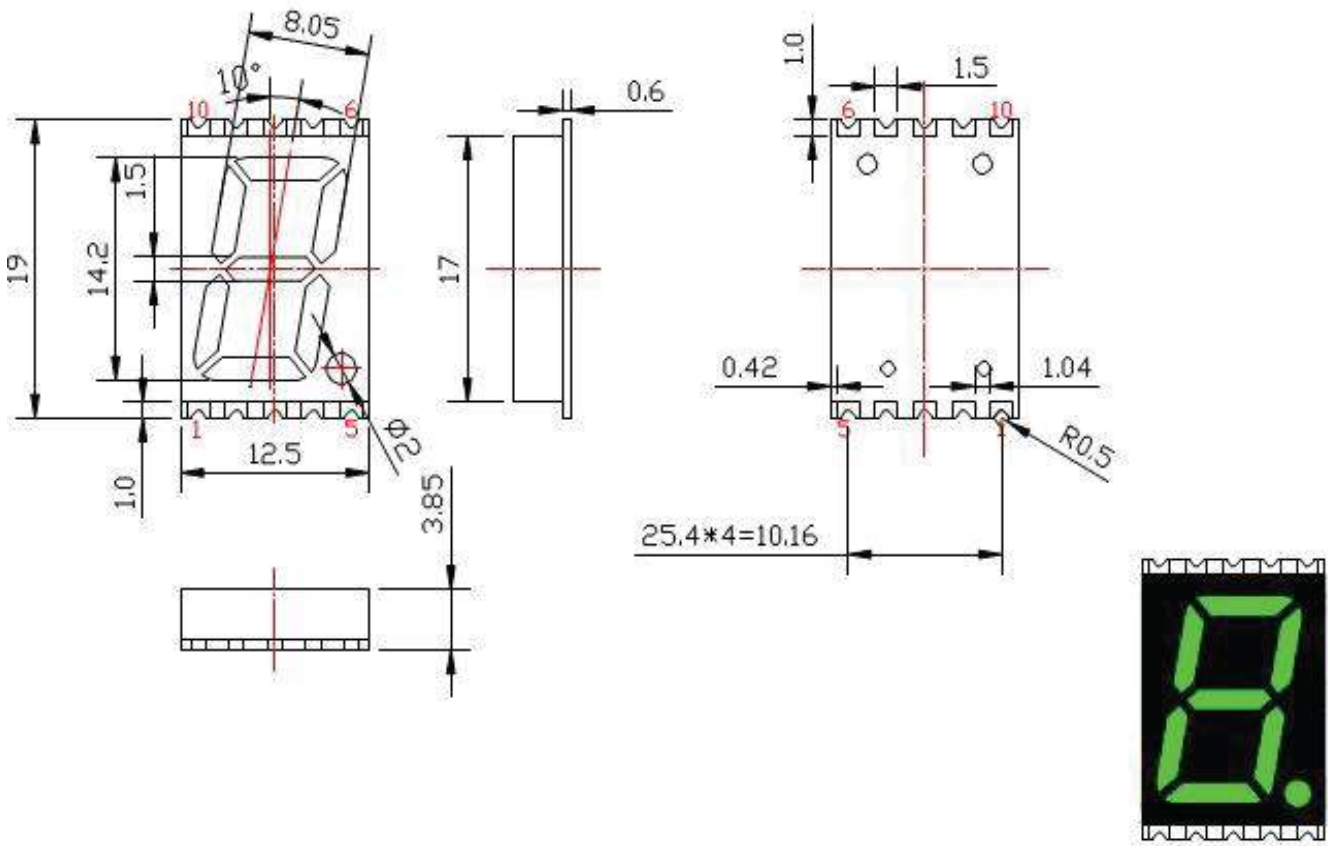
- 1-digit seven segment led numeric display
- Includes a decimal point (DP), useful when two or more seven-segment displays are connected to each other to display decimals
- White segments and black surface
- Substrate: InGaN
- Outer dimensions: 17.0 x 12.5 x 3.85mm
- High light output
- Excellent character appearance
- Quality tested with the highest industry standard
- Side by side mounting allows space saving
- Provides the ability to reduce overall thickness of PCB, with major cost savings
- Available in 3 different digit heights and widths
- Automation-friendly tape and reel
- Technically and mechanically rugged
- Small and light, easy assembly
- Life expectancy: up to 50,000 hours
- Lower power consumption
- Allow top mount and reverse mount design
- Mechanically rugged
- Moisture Sensitive Level (MSL): 2a
- Available in blue, red and pure green
- Polarity: common anode
- Easy mounting on PC boards or sockets
- Low current operation
- Degree of protection IP50 (Dust-Protected)

Ordering Data



*Please refer to DSM7U product datasheet for Ultra Thin Version
 **Only available for DSM7U Version

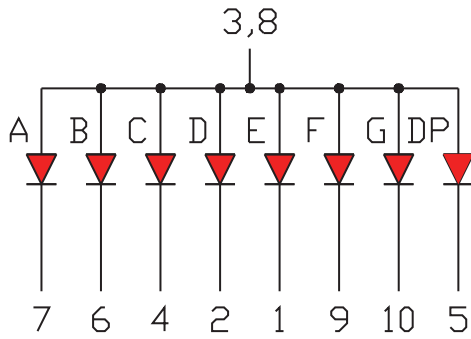
Dimensions and Internal Circuit Diagram



Dimensions in millimeters
 Tolerance is ±0.25mm unless otherwise noted

Internal Circuit Diagram

Pin Connections (Common Anode)



| PIN No | Connection |
|--------|--------------|
| 1 | CATHODE E |
| 2 | CATHODE D |
| 3 | COMMON ANODE |
| 4 | CATHODE C |
| 5 | CATHODE DP |
| 6 | CATHODE B |
| 7 | CATHODE A |
| 8 | COMMON ANODE |
| 9 | CATHODE F |
| 10 | CATHODE G |

Product Specifications

Absolute Maximum Ratings while Ta=25°C

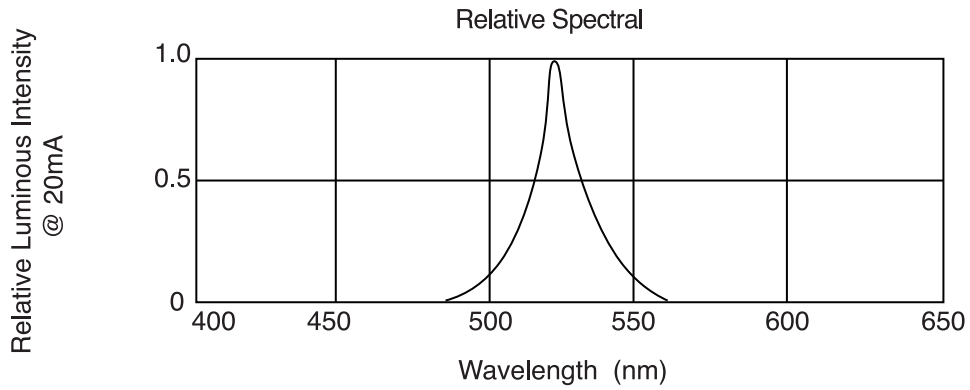
| Parameter | Minimum (m) | Maximum (M) | Unit |
|---------------------------------|-------------|-------------|------|
| Forward Current I_F /Seg | -- | 20 | mA |
| Reverse Voltage V_R /Seg | -- | 5 | V |
| Operating Temperature T_{OPR} | -30 | +85 | °C |
| Storage Temperature T_{STG} | -40 | +100 | °C |
| Peak Current I_{FM} /Seg | -- | 60 | mA |

(Notice: 1/10th duty cycle, 0.1ms pulse width)

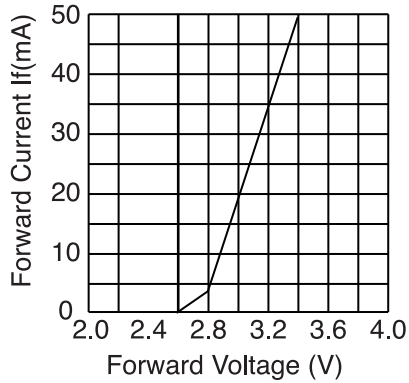
Electrical-Optical Characteristics while Ta=25°C

| Parameter | Condition | Unit | Minimum | Typical | Maximum |
|-------------------------------|--------------------|------|---------|---------|---------|
| Forward Voltage V_F /Seg | IF=20mA | V | 2.6 | 3.0 | 3.6 |
| Reverse Current I_R /Seg | VR=5V | μA | -- | -- | 50 |
| Wavelength λP | IF=20mA | nm | 520 | 525 | 530 |
| Full Width at Half Maximum Δλ | IF=20mA | nm | -- | 17.5 | -- |
| Luminosity I_v /Seg | IF=20mA | mcd | 100 | 150 | 220 |
| Viewing angle | wide viewing angle | | | | |

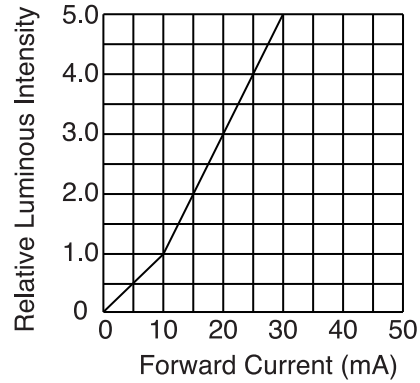
Product Specifications



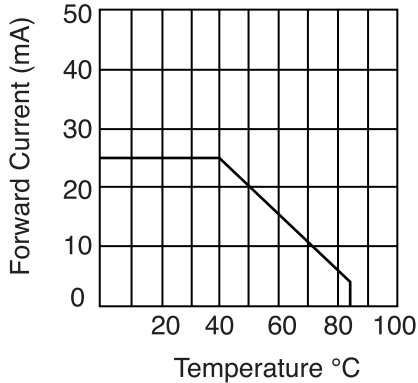
Forward Current vs. Forward Voltage



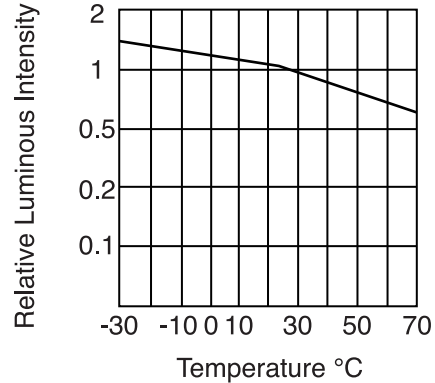
Relative Luminous Intensity vs. Forward current



Forward Current Vs. Temperature

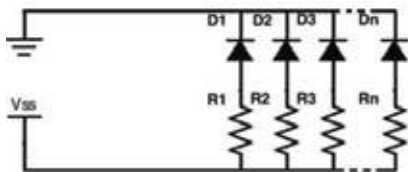


Luminous Intensity vs. Temperature

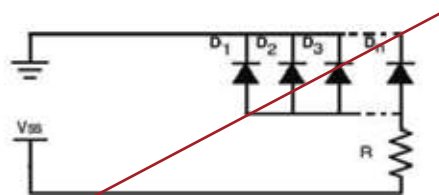


Circuit Design Notes

- Always use current limit resistors when necessary
- LEDs could be electrically connected in parallel, with each current limiting resistor

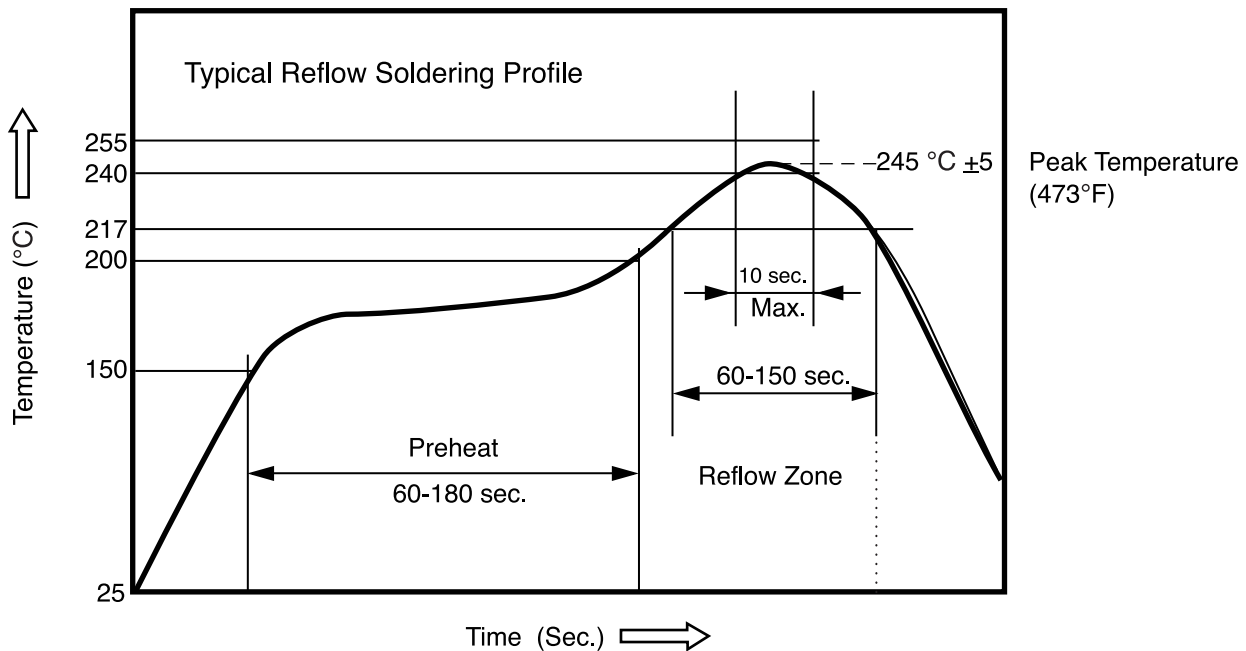


Correct



INCORRECT

Recommended Reflow Soldering Profile



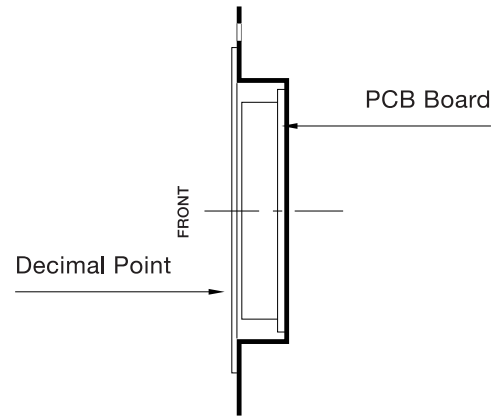
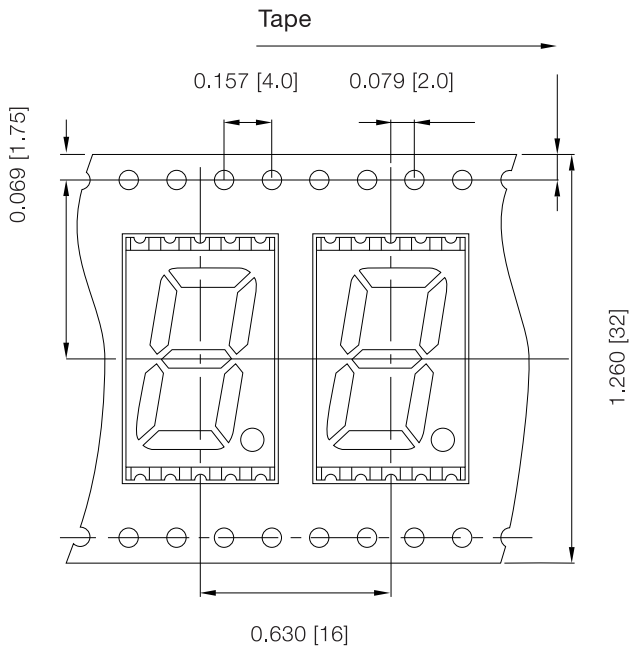
| Profile Feature | Typical Parameters |
|-----------------------------|--------------------|
| Preheat Temperature Min | 150 °C (302°F) |
| Preheat Temperature Max | 200 °C (392°F) |
| Preheat Time | 60 -180 sec. |
| Reflow Starting Temperature | 217 °C (423°F) |
| Time Spent During Reflow | 60 -150 sec. |
| Reflow Peak Temperature | 245 °C (473°F) |

- Manual soldering is suggested
 - Use soldering irons of which power is less than 30 Watt.
 - Keep the temperature of soldering irons below 360 °C
 - Only one soldering is allowed on each bonding pad.
 - The maximum time from when a soldering iron comes into contact with the parts that are to be connected until the joint is finished should not exceed three seconds.
 - Perform other procedures after the soldered pad cools down.
- Suggested storage conditions: 25°C +/-10°C (77°F +/-50°F), relative humidity 65% RH +/- 20% RH.

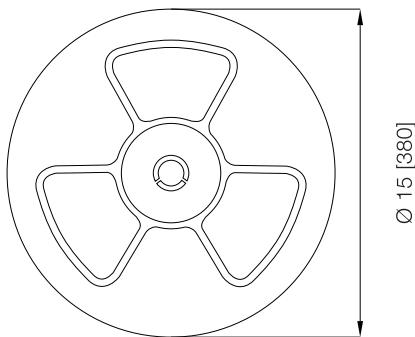
Tape and Reel Dimensions

Carrier band

Electrostatic Discharge (ESD) Package
Anti Static Bags Aluminium Moisture Barrier Bag.

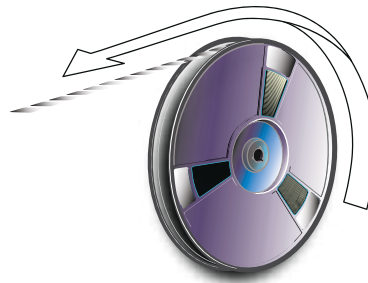


Reel Dimensions

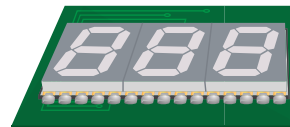


900PCS/Reel

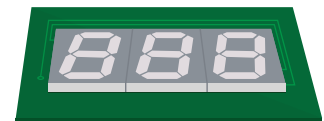
Direction of the feed



Allow top mount or reverse mount design



Top Mount



Reverse Mount

Dimensions in inches [millimeters]

Compliances and Approvals

